NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input

Rev. 4 — 7 November 2011

Product data sheet

1. General description

The NX3L4357 is a low-ohmic single-pole triple-throw analog switch suitable for use as an analog or digital 3:1 multiplexer/demultiplexer. It has two digital select inputs (S0 and S1), one digital enable input (\overline{E}), three independent inputs/outputs (Y0, Y1 and Y2) and a common input/output (Z). The device features a broadcast mode, when S0 and S1 are both high the signal applied to pin Z is passed to Y0, Y1 and Y2.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L4357 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L4357 allows signals with amplitude up to V_{CC} to be transmitted from Z to Yn or Yn to Z. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.65 Ω (typical) at V_{CC} = 1.4 V
 - 0.95 Ω (typical) at V_{CC} = 1.65 V
 - 0.55 Ω (typical) at V_{CC} = 2.3 V
 - 0.50 Ω (typical) at V_{CC} = 2.7 V
 - 0.50 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 6000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78B Class II Level A
- 1.8 V control logic at $V_{CC} = 3.6$ V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

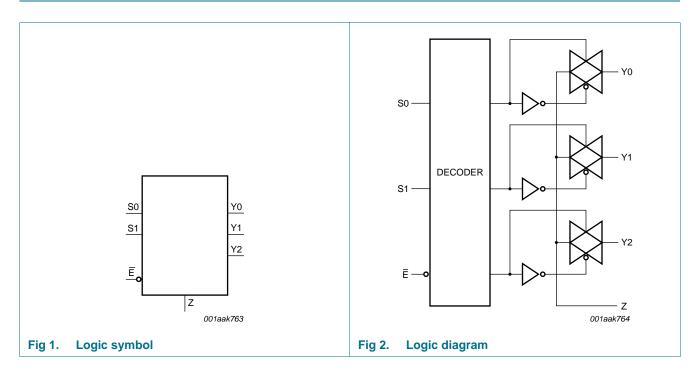
Table 1.Ordering information

Type number	Package									
	Temperature range	Name	Description	Version						
NX3L4357GM	–40 °C to +125 °C	XQFN10U	plastic extremely thin quad flat package; no leads; 10 terminals; UTLP based; body $2 \times 1.55 \times 0.5$ mm	SOT1049-2						

5. Marking

Table 2. Marking	
Type number	Marking code
NX3L4357GM	D43

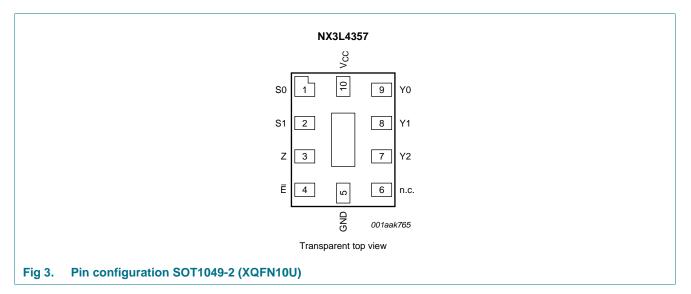
6. Functional diagram



NX3L4357 Product data sheet

7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
S0	1	select input
S1	2	select input
Z	3	common output or input
Ē	4	enable input (active LOW)
GND	5	ground (0 V)
n.c.	6	not connected
Y2	7	independent input or output
Y1	8	independent input or output
Y0	9	independent input or output
V _{CC}	10	supply voltage

3 of 21

8. Functional description

Table 4.	Function table ^[1]		
E	S1	S0	Channel on
L	L	L	Y0 = Z
L	L	Н	Y1 = Z
L	Н	L	Y2 = Z
L	Н	Н	Y0, Y1, Y2 = Z (broadcast mode)
Н	Х	Х	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

9. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	select input S0, S1 and \overline{E}	<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage		[2] -0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	V _I < -0.5 V	-50	-	mA
I _{SK}	switch clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±50	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current	-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3] _	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XQFN10U packages: above 132 °C the value of P_{tot} derates linearly with 14.1 mW/K.

10. Recommended operating conditions

Table 6.	Recommended operating con	ditions			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.4	4.3	V
VI	input voltage	select input S0, S1 and \overline{E}	0	4.3	V
V _{SW}	switch voltage	switch input Y0, Y1 and Y2	<u>[1]</u> 0	V _{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.4 V to 4.3 V	[2] _	200	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to select input Sn signal levels.

11. Static characteristics

Table 7.Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} =	T _{amb} = -40 °C to +125 °C		
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V _{IH}	HIGH-level	V _{CC} = 1.4 V to 1.6 V	0.9	-	-	0.9	-	-	V
i	input voltage	V _{CC} = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	1.3	-	-	1.3	-	-	V
		V_{CC} = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	V
V _{IL}	LOW-level	V_{CC} = 1.4 V to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.5	-	0.5	0.4	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		V_{CC} = 3.6 V to 4.3 V	-	-	0.6	-	0.6	0.6	V
I _I	input leakage current	select input S0, S1 and \overline{E} ; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μΑ
I _{S(OFF)}	OFF-state leakage	port Y0, Y1 and Y2; see <u>Figure 4</u>							
	current	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±10	±100	nA
		$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±10	-	±50	±200	nA
I _{S(ON)}	ON-state	Z port; see Figure 5							
	leakage current	V_{CC} = 1.4 V to 3.6 V	-	-	±5	-	±20	±200	nA
	current	V_{CC} = 3.6 V to 4.3 V	-	-	±10	-	±50	±400	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC}							
		V _{CC} = 3.6 V	-	-	100	-	300	3000	nA
		V_{CC} = 4.3 V	-	-	150	-	500	5000	nA
NX3L4357		All information provided in this	document is subje	ct to legal discl	aimers.		© NXP	B.V. 2011. All righ	its reserved

NX3L4357

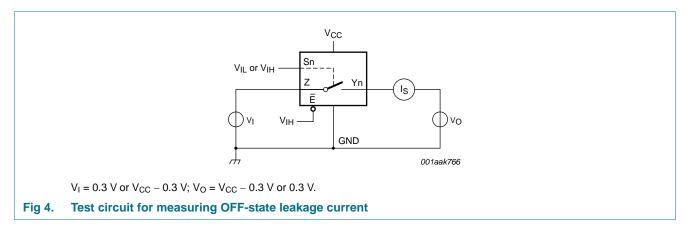
Low-ohmic single-pole triple-throw analog switch with enable input

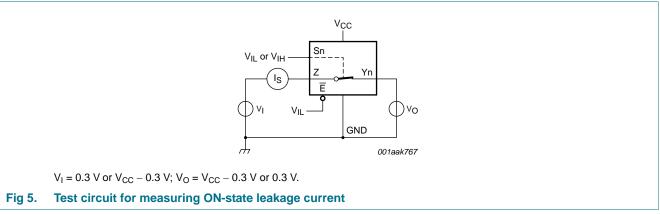
Symbol Parameter Conditions T_{amb} = 25 °C $T_{amb} = -40 \text{ °C to } +125 \text{ °C}$ Unit Min Max Min Max Max Тур (85 °C) (125 °C) $V_{SW} = GND \text{ or } V_{CC}$ additional ΔI_{CC} supply current $V_1 = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$ 7 7 2.0 4.0 -μΑ $V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$ 0.35 0.7 1 1 μA - $V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$ _ 7.0 10.0 _ 15 15 μΑ $V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$ 5 5 2.5 4.0 -μΑ $V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$ 50 200 300 500 nA --CI input pF _ 1.0 _ _ _ _ capacitance OFF-state port Y0, Y1 and Y2 35 C_{S(OFF)} -_ _ pF _ capacitance **ON-state** port Z; broadcast mode 330 pF C_{S(ON)} ----capacitance port Y0, Y1 and Y2 -170 ---pF

Table 7. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

11.1 Test circuits





11.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 7 to Figure 13.

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	• +85 °C	$T_{amb} = -40 \circ$	C to +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Max	
R _{ON(peak)}	ON resistance (peak)	port Y0, Y1 and Y2; V _I = GND to V _{CC} ; I _{SW} = 100 mA; see Figure 6						
		$V_{CC} = 1.4 V$	-	1.6	3.7	-	4.1	Ω
		V _{CC} = 1.65 V	-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 V$	-	0.55	0.8	-	0.9	Ω
		$V_{CC} = 2.7 V$	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω
ΔR_{ON}	ON resistance mismatch between channels	$V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$	[2]					
		$V_{CC} = 1.4 V$	-	0.20	0.35	-	0.35	Ω
		V _{CC} = 1.65 V	-	0.20	0.25	-	0.30	Ω
		$V_{CC} = 2.3 V$	-	0.09	0.13	-	0.15	Ω
		$V_{CC} = 2.7 V$	-	0.09	0.13	-	0.15	Ω
		$V_{CC} = 4.3 V$	-	0.09	0.13	-	0.15	Ω
R _{ON(flat)}	ON resistance (flatness)	port Y0, Y1 and Y2; V _I = GND to V _{CC} ; I_{SW} = 100 mA	[3]					
		$V_{CC} = 1.4 V$	-	1.05	3.35	-	3.65	Ω
		V _{CC} = 1.65 V	-	0.55	1.25	-	1.35	Ω
		$V_{CC} = 2.3 V$	-	0.20	0.35	-	0.40	Ω
		$V_{CC} = 2.7 V$	-	0.18	0.35	-	0.40	Ω
		$V_{CC} = 4.3 V$	-	0.23	0.40	-	0.45	Ω

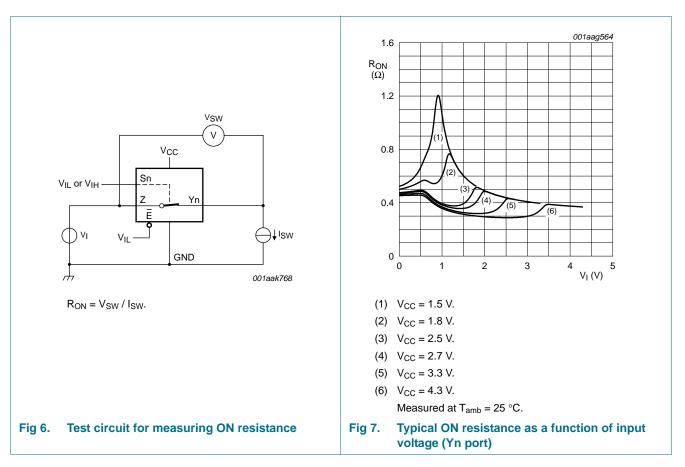
[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] Measured at identical V_{CC} , temperature and input voltage.

[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

NX3L4357

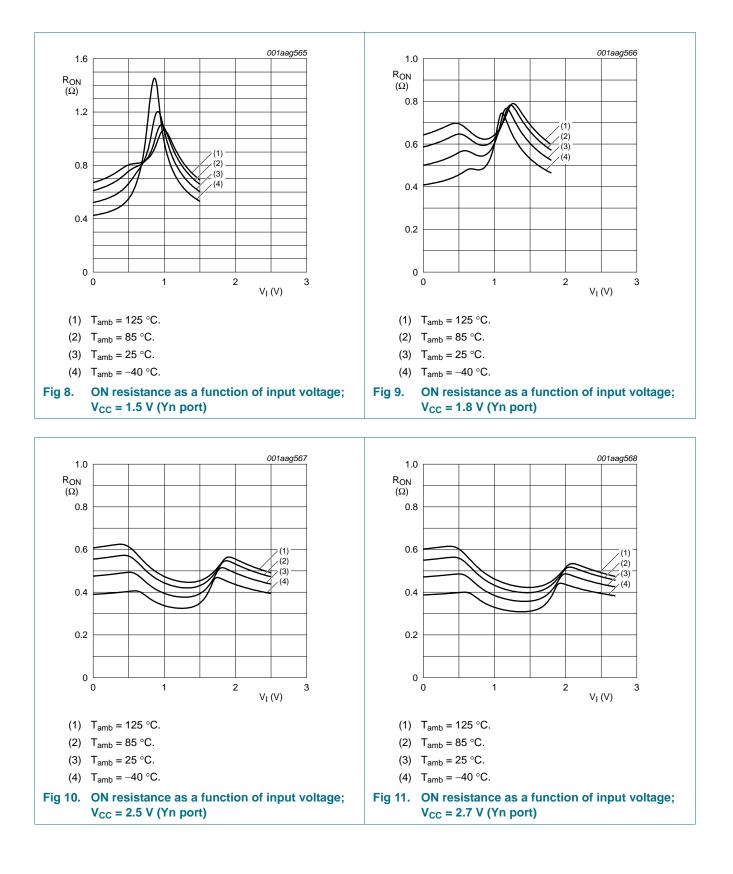
Low-ohmic single-pole triple-throw analog switch with enable input



11.3 ON resistance test circuit and graphs

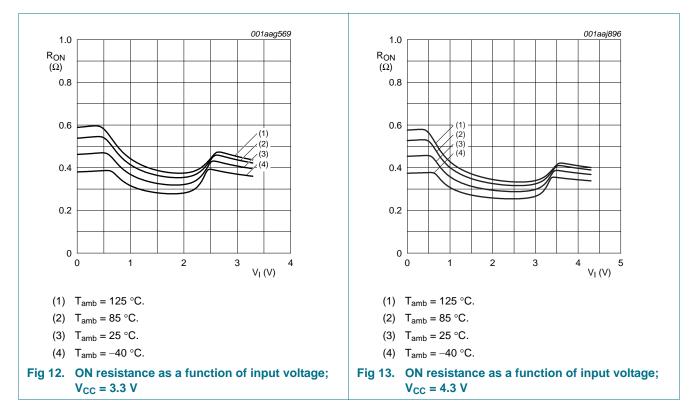
NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input



NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input



12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 16.

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
t _{en}	enable time	Ē, Sn to Z or Yn; see <u>Figure 14</u>							
		V_{CC} = 1.4 V to 1.6 V	-	50	100	-	120	125	ns
		V_{CC} = 1.65 V to 1.95 V	-	36	75	-	85	95	ns
		V_{CC} = 2.3 V to 2.7 V	-	24	50	-	55	60	ns
		V_{CC} = 2.7 V to 3.6 V	-	22	45	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V	-	22	45	-	45	50	ns
t _{dis}	disable time	Ē, Sn to Z or Yn; see <u>Figure 14</u>							
		V_{CC} = 1.4 V to 1.6 V	-	32	80	-	90	105	ns
		V_{CC} = 1.65 V to 1.95 V	-	20	65	-	70	75	ns
		V_{CC} = 2.3 V to 2.7 V	-	12	30	-	35	40	ns
		V_{CC} = 2.7 V to 3.6 V	-	10	25	-	30	35	ns
		V_{CC} = 3.6 V to 4.3 V	-	10	25	-	30	35	ns

10 of 21

Symbol	Parameter	Conditions		T _{amb} = 25 °C			T _{amb} = –40 °C to +125 °C			Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	-
t _{b-m}	break-before-make	see Figure 15	[2]						1	
time	time	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		-	19	-	9	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V		-	13	-	4	-	-	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		-	10	-	3	-	-	ns
		V_{CC} = 3.6 V to 4.3 V		-	10	-	2	-	-	ns

Table 9. Dynamic characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 16.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

12.1 Waveforms and test circuits

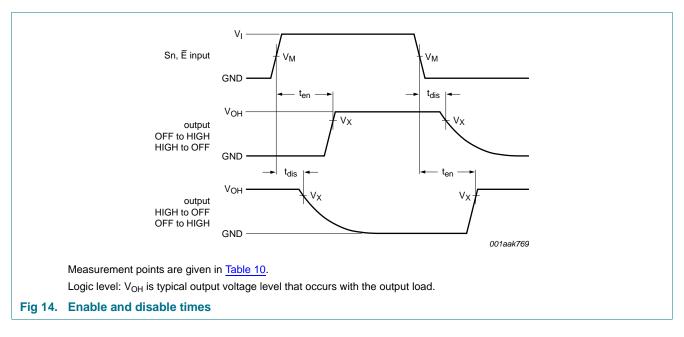
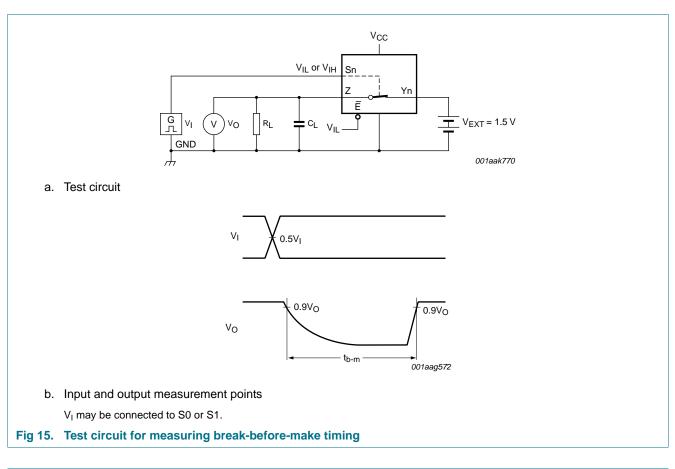


Table 10. Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _X
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}

NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input



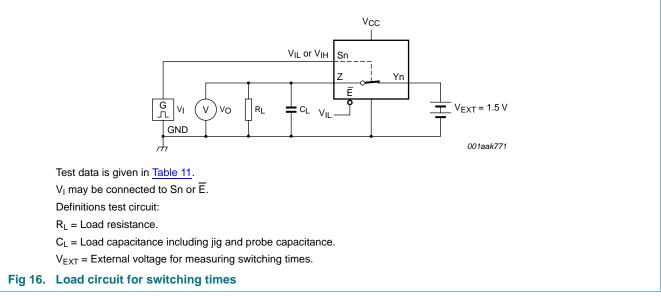


Table 11. Test data

Supply voltage	Input		Load	
V _{cc}	VI	t _r , t _f	CL	RL
1.4 V to 4.3 V	V _{CC}	\leq 2.5 ns	35 pF	50 Ω

NX3L	4357	,	
_			

12.2 Additional dynamic characteristics

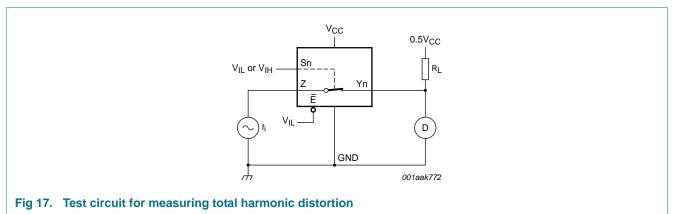
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns.

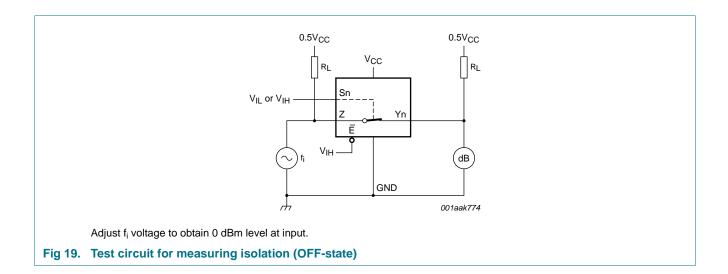
Symbol	Parameter	Conditions	T _{amb} = 25 °C			Unit	
				Min	Тур	Max	
THD	total harmonic distortion	$f_i = 20$ Hz to 20 kHz; $R_L = 32 \Omega$; see Figure 17	<u>[1]</u>				
		V _{CC} = 1.4 V; V _I = 1 V (p-p)		-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)		-	0.10	-	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)		-	0.02	-	%
		V _{CC} = 2.7 V; V ₁ = 2 V (p-p)		-	0.02	-	%
		V _{CC} = 4.3 V; V _I = 2 V (p-p)		-	0.02	-	%
		V_{CC} = 3.0 V; V _I = 1 V (p-p); R _L = 600 Ω		-	0.01	-	%
f _(-3dB)	-3 dB frequency	$R_L = 50 \Omega$; see Figure 18	<u>[1]</u>				
. ,	response	port Y0, Y1 or Y2; V_{CC} = 1.4 V to 4.3 V		-	30	-	MHz
		port Y0, Y1 and Y2; V_{CC} = 1.4 V to 4.3 V		-	20	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}; R_L = 50 \Omega; \text{ see } \frac{\text{Figure 19}}{100 \text{ kHz}}$	<u>[1]</u>				
		V_{CC} = 1.4 V to 4.3 V		-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 20					
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$		-	0.21	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$		-	0.30	-	V
Xtalk cross	crosstalk	between switches; $f_i = 100 \text{ kHz}$; $R_L = 50 \Omega$; see Figure 21	<u>[1]</u>				
		$V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$		-	-90	-	dB
Q _{inj}	charge injection	f_i = 1 MHz; C_L = 0.1 nF; R_L = 1 MΩ; V_{gen} = 0 V; R_{gen} = 0 Ω; see <u>Figure 22</u>					
		$V_{CC} = 1.5 V$		-	10	-	рС
		V _{CC} = 1.8 V		-	15	-	рС
		$V_{CC} = 2.5 V$		-	26	-	рС
		$V_{CC} = 3.3 V$		-	36	-	рС
		$V_{CC} = 4.3 V$		-	50	-	рС

[1] f_i is biased at 0.5V_{CC}.

12.3 Test circuits



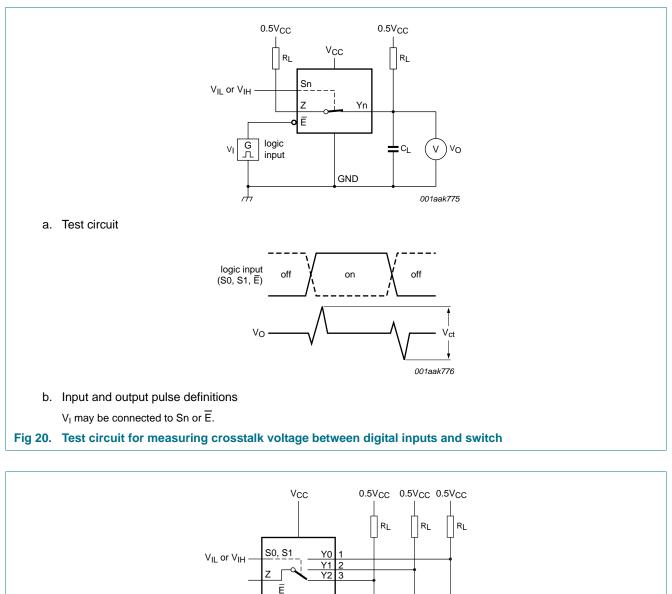
V_{CC} $0.5V_{CC}$ VIL or VIH Rı Yn Ē Vıı dB GND 001aak773 Adjust fi voltage to obtain 0 dBm level at output. Increase fi frequency until dB meter reads -3 dB. Fig 18. Test circuit for measuring the frequency response when channel is in ON-state



NX3L4357

NX3L4357

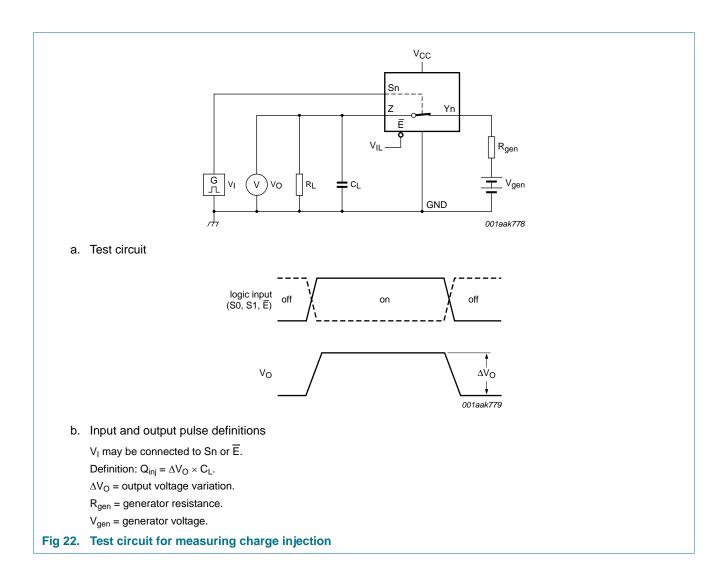
Low-ohmic single-pole triple-throw analog switch with enable input



 $V_{IH} \xrightarrow{\qquad \qquad } f_i \xrightarrow{\qquad } f_i \xrightarrow{\qquad } f_i \xrightarrow{\qquad } dB \xrightarrow{\qquad } d$

NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input



NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input

13. Package outline

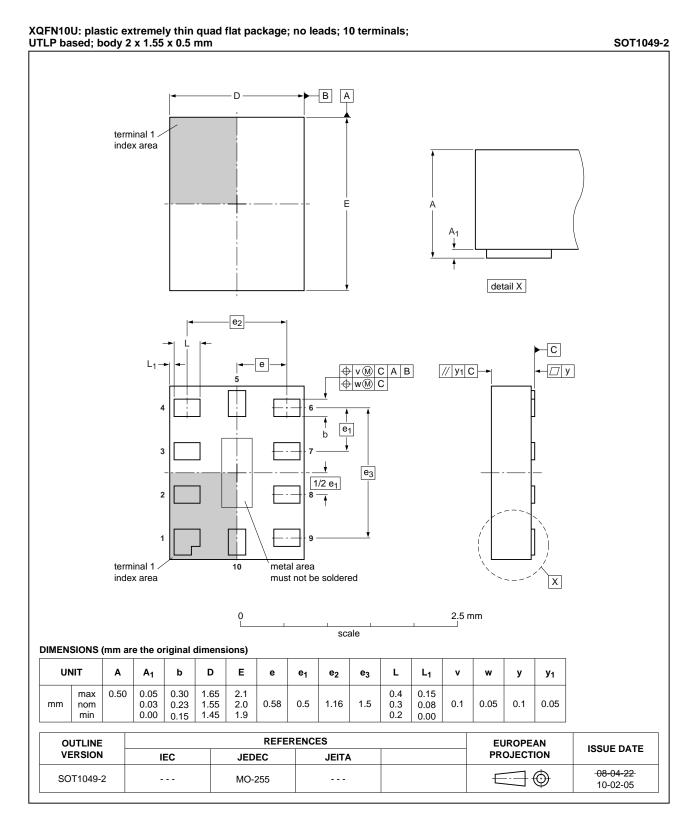


Fig 23. Package outline SOT1049-2 (XQFN10U)

All information provided in this document is subject to legal disclaimers.

NX3L4357

© NXP B.V. 2011. All rights reserved.

14. Abbreviations

Table 13. Abbreviations			
Acronym	Description		
CDM	Charged Device Model		
CMOS	Complementary Metal-Oxide Semiconductor		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		

15. Revision history

Table 14.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L4357 v.4	20111107	Product data sheet	-	NX3L4357 v.3
Modifications:	 Legal pages 	s updated.		
NX3L4357 v.3	20101228	Product data sheet	-	NX3L4357 v.2
NX3L4357 v.2	20100428	Product data sheet	-	NX3L4357 v.1
NX3L4357 v.1	20091019	Product data sheet	-	-

18 of 21

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

16.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

NX3L4357

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2011. All rights reserved.

NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

17. Contact information

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

20 of 21

NX3L4357

Low-ohmic single-pole triple-throw analog switch with enable input

18. Contents

2	Features and benefits 1
3	Applications 2
4	Ordering information 2
5	Marking
6	Functional diagram 2
7	Pinning information 3
7.1	Pinning
7.2	Pin description 3
8	Functional description 4
9	Limiting values 4
10	Recommended operating conditions 5
11	Static characteristics 5
11.1	Test circuits 6
11.2	ON resistance 7
11.3	ON resistance test circuit and graphs 8
12	Dynamic characteristics 10
12.1	Waveforms and test circuits 11
12.2	Additional dynamic characteristics 13
12.3	Test circuits 14
13	Package outline 17
14	Abbreviations 18
15	Revision history 18
16	Legal information 19
16.1	Data sheet status 19
16.2	Definitions 19
16.3	Disclaimers
16.4	Trademarks 20
17	Contact information 20
18	Contents 21

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 7 November 2011 Document identifier: NX3L4357